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BYV26DGP, BYV26EGP



Superectifier[®]

DO-15 (DO-204AC)

1.0 A

800 V, 1000 V

30 A

75 ns

1.3 V

175 °C

DO-15 (DO-204AC)

Single

PRIMARY CHARACTERISTICS

I_{F(AV)}

V_{RRM}

I_{FSM} t_{rr}

 $V_{\rm F}$ at $I_{\rm F}$

T_J max.

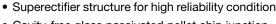
Package

Circuit configuration

Vishay General Semiconductor

Glass Passivated Ultrafast Plastic Rectifier





- Cavity-free glass passivated pellet chip junction
- Ultrafast reverse recovery time
- Low forward voltage drop

FEATURES

- Low switching losses, high efficiency
- High forward surge capability
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer and telecommunication.

MECHANICAL DATA

Case: DO-15 (DO-204AC), molded epoxy over glass body Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	BYV26DGP	BYV26EGP	UNIT		
Maximum repetitive peak reverse voltage	V _{RRM}	800	1000	V		
Maximum RMS voltage	V _{RMS}	560	700	V		
Maximum DC blocking voltage	V _{DC}	800	1000	V		
Maximum average forward rectified current 0.375" (9.5 mm) lead length (fig. 1)	I _{F(AV)}	1.0		А		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30		А		
Non repetitive peak reverse energy	E _{RSM} ⁽¹⁾	10		mJ		
Operating junction and storage temperature range	T _J , T _{STG}	-65 to +175		°C		

Note

⁽¹⁾ Peak reverse energy measured at $I_R = 400$ mA, $T_J = T_J$ max. on inductive load, t = 20 µs



COMPLIANT



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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	BYV26DGP	BYV26EGP	UNIT	
Minimum avalanche breakdown voltage	100 µA		V _{BR}	900	1100	V	
Maximum instantaneous forward voltage	104	T _J = 25 °C		2.5		V	
	1.0 A	T _J = 175 °C	V _F	1.3		v	
Maximum DC reverse current at rated DC		T _A = 25 °C		5.	0		
blocking voltage		T _A = 165 °C	IR I	150		μΑ	
Max. reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	75		ns	
Typical junction capacitance	4.0 V, 1 MHz		CJ	15		pF	

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	BYV26DGP	BYV26EGP	UNIT		
Typical thermal resistance	R _{0JA} ⁽¹⁾	70		°C/W		
Typical merma resistance	R _{θJL} ⁽²⁾	16				

Notes

(1) Thermal resistance from junction to ambient at 0.375" (9.5 mm) lead length, mounted on PCB with 0.5" x 0.5" (12 mm x 12 mm) copper pads

⁽²⁾ Thermal resistance from junction to lead at 0.375" (9.5 mm) lead length with both leads attached to heatsink

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
BYV26EGP-E3/54	0.428	54	4000	13" diameter paper tape and reel		
BYV26EGP-E3/73	0.428	73	2000	Ammo pack packaging		



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

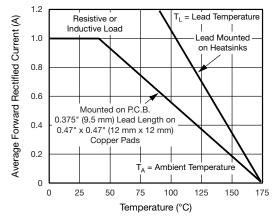


Fig. 1 - Maximum Forward Current Derating Curve

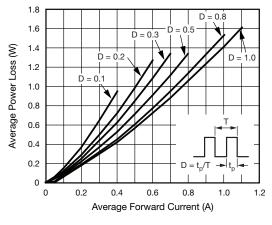


Fig. 2 - Forward Power Loss Characteristics

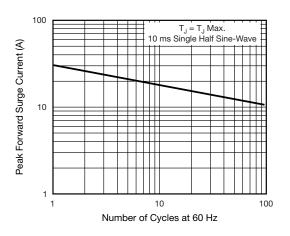


Fig. 3 - Maximum Non-Repetitive Peak Forward Surge Current

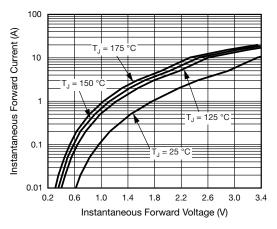


Fig. 4 - Typical Instantaneous Forward Voltage Characteristics

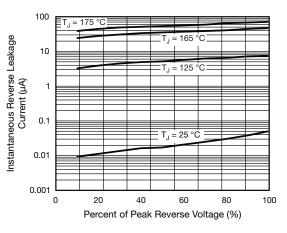


Fig. 5 - Typical Reverse Leakage Characteristics

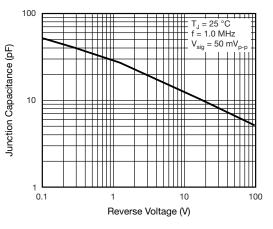


Fig. 6 - Typical Junction Capacitance

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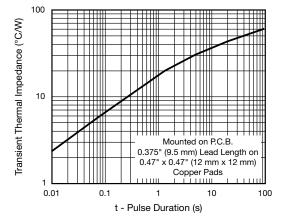
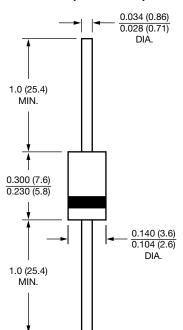


Fig. 7 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



DO-15 (DO-204AC)



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